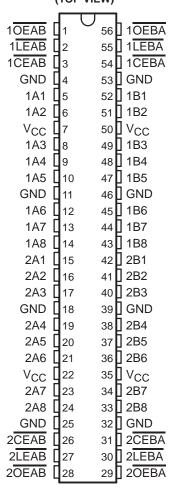
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- State-of-the-Art Advanced BiCMOS Technology (ABT) Design for 3.3-V Operation and Low-Static Power Dissipation
- Members of the Texas Instruments Widebus™ Family
- Support Mixed-Mode Signal Operation (5-V Input and Output Voltages With 3.3-V V_{CC})
- Support Unregulated Battery Operation Down to 2.7 V
- Typical V_{OLP} (Output Ground Bounce)
 < 0.8 V at V_{CC} = 3.3 V, T_A = 25°C
- ESD Protection Exceeds 2000 V Per MIL-STD-883C, Method 3015; Exceeds 200 V Using Machine Model (C = 200 pF, R = 0)
- Latch-Up Performance Exceeds 500 mA Per JEDEC Standard JESD-17
- Bus-Hold Data Inputs Eliminate the Need for External Pullup Resistors
- Support Live Insertion
- Distributed V_{CC} and GND Pin Configuration Minimizes High-Speed Switching Noise
- Flow-Through Architecture Optimizes
 PCB Lavout
- Package Options Include Plastic 300-mil Shrink Small-Outline (DL) and Thin Shrink Small-Outline (DGG) Packages and 380-mil Fine-Pitch Ceramic Flat (WD) Package Using 25-mil Center-to-Center Spacings

SN54LVT16543 . . . WD PACKAGE SN74LVT16543 . . . DGG OR DL PACKAGE (TOP VIEW)



description

The 'LVT16543 are 16-bit registered transceivers designed for low-voltage (3.3-V) V_{CC} operation, but with the capability to provide a TTL interface to a 5-V system environment. These devices can be used as two 8-bit transceivers or one 16-bit transceiver. Separate latch-enable (\overline{LEAB} or \overline{LEAB}) and output-enable (\overline{OEAB} or \overline{OEBA}) inputs are provided for each register to permit independent control in either direction of data flow.

The A-to-B enable (\overline{CEAB}) input must be low in order to enter data from A or to output data from B. If \overline{CEAB} is low and \overline{LEAB} is low, the A-to-B latches are transparent; a subsequent low-to-high transition of \overline{LEAB} puts the A latches in the storage mode. With \overline{CEAB} and \overline{OEAB} both low, the 3-state B outputs are active and reflect the data present at the output of the A latches. Data flow from B to A is similar but requires using the \overline{CEBA} , and \overline{OEBA} inputs.

Active bus-hold circuitry is provided to hold unused or floating data inputs at a valid logic level.



Please be aware that an important notice concerning availability, standard warranty, and use in critical applications of Texas Instruments semiconductor products and disclaimers thereto appears at the end of this data sheet.

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TEXAS INSTRUMENTS

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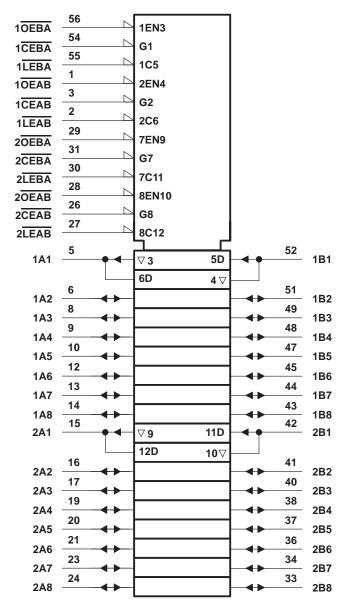
description (continued)

To ensure the high-impedance state during power up or power down, \overline{OE} should be tied to V_{CC} through a pullup resistor; the minimum value of the resistor is determined by the current-sinking capability of the driver.

The SN74LVT16543 is available in TI's shrink small-outline (DL) and thin shrink small-outline (DGG) packages, which provide twice the I/O pin count and functionality of standard small-outline packages in the same printed-circuit-board area.

The SN54LVT16543 is characterized for operation over the full military temperature range of –55°C to 125°C. The SN74LVT16543 is characterized for operation from –40°C to 85°C.

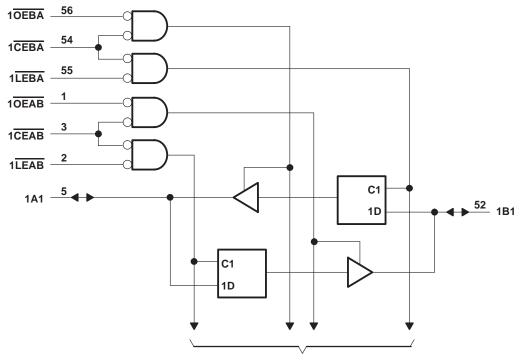
logic symbol†



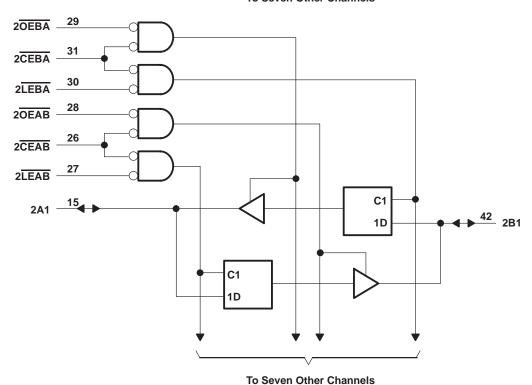
[†] This symbol is in accordance with ANSI/IEEE Std 91-1984 and IEC Publication 617-12.



logic diagram (positive logic)



To Seven Other Channels



TEXAS INSTRUMENTS

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FUNCTION TABLE[†] (each 8-bit section)

| | INPUTS | | | | | | | | |
|------|--------|------|---|------------------|--|--|--|--|--|
| CEAB | LEAB | OEAB | Α | В | | | | | |
| Н | Х | Χ | Χ | Z | | | | | |
| Х | Χ | Н | X | Z | | | | | |
| L | Н | L | Χ | в ₀ ‡ | | | | | |
| L | L | L | L | L | | | | | |
| L | L | L | Н | Н | | | | | |

[†] A-to-B data flow is shown; B-to-A flow control is the same except that it uses CEBA, LEBA, and OEBA.

absolute maximum ratings over operating free-air temperature range (unless otherwise noted)§

| Supply voltage range, V _{CC} –0. | 5 V to 4 6 V |
|---|--------------|
| | |
| Input voltage range, V _I (see Note 1) | 0.5 V to 7 V |
| Voltage range applied to any output in the high state or power-off state, VO (see Note 1) | 0.5 V to 7 V |
| Current into any output in the low state, IO: SN54LVT16543 | 96 mA |
| SN74LVT16543 | 128 mA |
| Current into any output in the high state, IO (see Note 2): SN54LVT16543 | 48 mA |
| SN74LVT16543 | |
| Input clamp current, I_{IK} ($V_I < 0$) | –50 mA |
| Output clamp current, I _{OK} (V _O < 0) | –50 mA |
| Maximum power dissipation at T _A = 55°C (in still air) (see Note 3): DGG package | 1 W |
| DL package | 1.4 W |
| Storage temperature range, T _{stq} –65 | |

[§] Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

- NOTES: 1. The input and output negative-voltage ratings may be exceeded if the input and output clamp-current ratings are observed.
 - 2. This current flows only when the output is in the high state and $V_O > V_{CC}$.
 - 3. The maximum package power dissipation is calculated using a junction temperature of 150°C and a board trace length of 750 mils. For more information, refer to the *Package Thermal Considerations* application note in the 1994 *ABT Advanced BiCMOS Technology Data Book*, literature number SCBD002B.

recommended operating conditions (see Note 4)

| | | | SN54LV | T16543 | SN74LV | T16543 | |
|----------|---|-----------------|--------|--------|--------|--------|------|
| | | | MIN | MAX | MIN | MAX | UNIT |
| VCC | Supply voltage | | 2.7 | 3.6 | 2.7 | 3.6 | V |
| VIH | High-level input voltage | 2 | FIN | 2 | | V | |
| V_{IL} | Low-level input voltage | | | | | 0.8 | V |
| VI | Input voltage | | | 5.5 | | 5.5 | V |
| ІОН | High-level output current | | Ç | -24 | | -32 | mA |
| loL | I _{OL} Low-level output current | | | 48 | | 64 | mA |
| Δt/Δν | Input transition rise or fall rate | Outputs enabled | Sp. | 10 | | 10 | ns/V |
| TA | T _A Operating free-air temperature | | | 125 | -40 | 85 | °C |

NOTE 4: Unused control inputs must be held high or low to prevent them from floating.



[‡] Output level before the indicated steady-state input conditions were established

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electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

| | _ | | | SN5 | 4LVT16 | 543 | SN7 | '4LVT16 | 543 | |
|--------------------|---|---|------------------|-------|------------------|------|-------|------------------|------|------|
| PARAMETER | " | EST CONDITIONS | | MIN | TYP [†] | MAX | MIN | TYP [†] | MAX | UNIT |
| VIK | $V_{CC} = 2.7 \text{ V},$ | I _I = -18 mA | | | -1.2 | | | -1.2 | V | |
| | $V_{CC} = MIN \text{ to } MAX^{\ddagger},$ | I _{OH} = -100 μA | | VCC-C |).2 | | VCC-0 | .2 | | |
| ., | $V_{CC} = 2.7 \text{ V},$ | I _{OH} = – 8 mA | | 2.4 | | | 2.4 | | | V |
| VOH | | I _{OH} = - 24 mA | 2 | | | | | | V | |
| | V _{CC} = 3 V | $I_{OH} = -32 \text{ mA}$ | | | | 2 | | | | |
| | V 07V | I _{OL} = 100 μA | | | | 0.2 | | | 0.2 | |
| | V _{CC} = 2.7 V | I _{OL} = 24 mA | | | | 0.5 | | | 0.5 | |
| ļ ,, | | I _{OL} = 16 mA | | | | 0.4 | | | 0.4 | |
| V _{OL} | 2.7 | I _{OL} = 32 mA | | | | 0.5 | | | 0.5 | V |
| | V _{CC} = 3 V | I _{OL} = 48 mA | | | 0.55 | | | | | |
| | | I _{OL} = 64 mA | | N. | | | 0.55 | | | |
| | $V_{CC} = 3.6 \text{ V},$ | V _I = V _{CC} or GND | | | 1 | ±1 | | | ±1 | |
| | $V_{CC} = 0$ or MAX ‡ , | V _I = 5.5 V | Control inputs | 8 | | 10 | | | 10 | |
| l _l | V _{CC} = 3.6 V | V _I = 5.5 V | | | 6 | 20 | | | 20 | μΑ |
| | | VI = VCC | A or B ports§ | | 30 | 5 | | | 5 | |
| | | V _I = 0 | 1 | 0 | | -10 | | | -10 | |
| l _{off} | $V_{CC} = 0$, | V_{I} or $V_{O} = 0$ to 4.5 | V | - V | | | | | ±100 | μΑ |
| | V 2 V | V _I = 0.8 V | A = D = = = = = | 75 | | | 75 | | | ^ |
| l(hold) | VCC = 3 V | V _I = 2 V | A or B ports | -75 | | | -75 | | | μΑ |
| lozh | $V_{CC} = 3.6 \text{ V},$ | V _O = 3 V | | | | 1 | | | 1 | μΑ |
| lozL | $V_{CC} = 3.6 \text{ V},$ | $V_0 = 0.5 V$ | | | | -1 | | | -1 | μΑ |
| | | | Outputs high | | | 0.12 | | | 0.12 | |
| ICC | $V_{CC} = 3.6 \text{ V},$ $V_{I} = V_{CC} \text{ or GND}$ | $I_O = 0$, | Outputs low | | | 5 | | | 5 | mA |
| | V1 = VCC 01 014B | | Outputs disabled | | | 0.12 | | | 0.12 | |
| ΔI _{CC} ¶ | V_{CC} = 3 V to 3.6 V, One input at V_{CC} – 0.6 V, Other inputs at V_{CC} or GND | | | | | 0.2 | | | 0.2 | mA |
| C _i | V _I = 3 V or 0 | | | | 4 | | | 4 | | pF |
| C _{io} | $V_O = 3 \text{ V or } 0$ | | | | 13 | | | 13 | | pF |



[†] All typical values are at V_{CC} = 3.3 V, T_A = 25°C. ‡ For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions.

[§] Unused pins at V_{CC} or GND

This is the increase in supply current for each input that is at the specified TTL voltage level rather than VCC or GND.

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timing requirements over recommended operating free-air temperature range (unless otherwise noted) (see Figure 1)

| | | | | ; | SN54LV | T16543 | | ; | SN74LV | T16543 | | | |
|-----------------|------------------------|------------------------|-----------|-------------------|--------|-------------------|-------|-------------------|--------|-------------------|-------|------|--|
| | | | | V _{CC} = | | V _{CC} = | 2.7 V | V _{CC} = | | V _{CC} = | 2.7 V | UNIT | |
| | | | | MIN | MAX | MIN | MAX | MIN | MAX | MIN | MAX | | |
| t _W | Pulse durati | on, LEAB or LEBA low | | 3.3 | | 3.3 | | 3.3 | | 3.3 | | ns | |
| | A or B before LEAB↑ or | | Data high | 0.8 | | 0.5 | | 0.8 | | 0.5 | | | |
| | | <u>LEBA</u> ↑ | Data low | 1.5 | | 1.9 | | 1.5 | | 1.9 | | ns | |
| t _{su} | Setup time | A or B before CEAB↑ or | Data high | 0.7 | | 0.4 | | 0.7 | | 0.4 | | | |
| | | CEBA↑ | Data low | 1.6 | | 1.9 | | 1.6 | | 1.9 | | ns | |
| | | A or B after LEAB↑ or | Data high | 0.8 | 2 | 0 | | 0.8 | | 0 | | | |
| | <u>LEBA</u> ↑ | Data low | 1.2 | 0,00 | 1.3 | | 1.2 | | 1.3 | | ns | | |
| th | th Hold time | A or B after CEAB↑ or | Data high | 0.8 | Q. | 0 | | 0.8 | | 0 | | | |
| | | CEBA↑ | Data low | 1.3 | | 1.4 | | 1.3 | | 1.4 | | ns | |

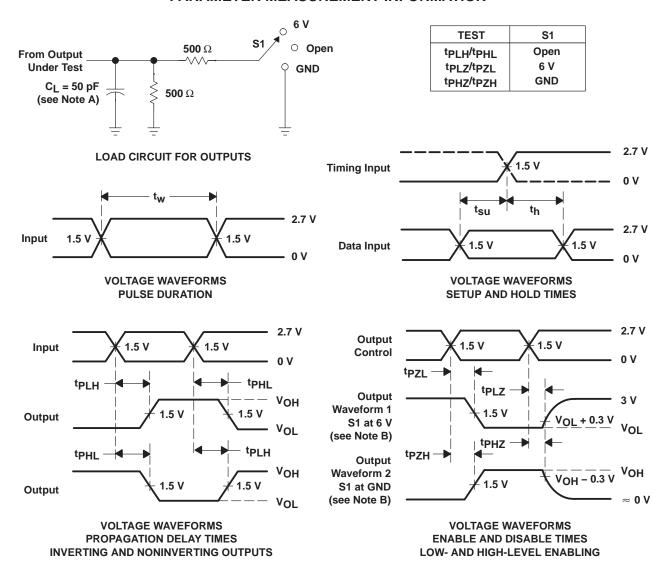
switching characteristics over recommended operating free-air temperature range, $C_L = 50 \text{ pF}$ (unless otherwise noted) (see Figure 1)

| | | | | SN54LV | T16543 | | | SN7 | 4LVT16 | 543 | | |
|------------------|-----------------|-----------|-----|------------------------------|--------|-------------------------|-----|------------------------------------|--------|-----|-------|------|
| PARAMETER | FROM (INPUT) | | | V_{CC} = 3.3 V \pm 0.3 V | | V _{CC} = 2.7 V | | V _{CC} = 3.3 V ± 0.3 V | | | 2.7 V | UNIT |
| | | | MIN | MAX | MIN | MAX | MIN | TYP [†] | MAX | MIN | MAX | |
| ^t PLH | A D | D on A | 1.4 | 5 | | 5.8 | 1.4 | 2.7 | 4.6 | | 5.5 | |
| ^t PHL | A or B | B or A | 1.3 | 4.7 | | 5.9 | 1.3 | 2.9 | 4.6 | | 5.8 | ns |
| t _{PLH} | <u>IE</u> | A - :: D | 1.3 | 6.8 | M: | 8.5 | 1.7 | 3.7 | 6.3 | | 8.1 | |
| t _{PHL} | LE | A or B | 1.5 | 6.5 | M: | 8.3 | 1.9 | 3.7 | 6 | | 7.8 | ns |
| ^t PZH | ŌĒ | A - :: D | 1.4 | 6 | 4 | 7.7 | 1.5 | 3.3 | 5.8 | | 7.6 | |
| t _{PZL} | OE | A or B | 1.6 | 6.3 | , | 8.4 | 1.6 | 3.3 | 6.2 | | 8.2 | ns |
| ^t PHZ | ŌĒ | A - : : D | 2 | 6.7 | | 7.3 | 2 | 4.1 | 6.5 | | 7.1 | |
| t _{PLZ} | OE | A or B | 2.7 | 6 | | 6.2 | 2.7 | 3.9 | 5.8 | | 5.9 | ns |
| ^t PZH | CE | A - : : D | 1.4 | 6.2 | | 7.7 | 1.5 | 3.3 | 6 | | 7.6 | |
| t _{PZL} | CE | A or B | 1.6 | 6.6 | | 8.5 | 1.7 | 3.3 | 6.4 | | 8.3 | ns |
| ^t PHZ | CE | A or D | 2 | 6.6 | | 7.2 | 2 | 4.1 | 6.4 | | 7.1 | |
| ^t PLZ | CE | A or B | 2.6 | 5.6 | | 5.9 | 2.6 | 4 | 5.4 | | 5.6 | ns |

[†] All typical values are at V_{CC} = 3.3 V, T_A = 25°C.

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PARAMETER MEASUREMENT INFORMATION



NOTES: A. C_L includes probe and jig capacitance.

- B. Waveform 1 is for an output with internal conditions such that the output is low except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high except when disabled by the output control.
- C. All input pulses are supplied by generators having the following characteristics: PRR \leq 10 MHz, $Z_Q = 50 \Omega$, $t_f \leq 2.5$ ns. $t_f \leq 2.5$ ns.
- D. The outputs are measured one at a time with one transition per measurement.

Figure 1. Load Circuit and Voltage Waveforms



TAPE AND REEL INFORMATION





| | Dimension designed to accommodate the component width |
|----|---|
| B0 | Dimension designed to accommodate the component length |
| K0 | Dimension designed to accommodate the component thickness |
| W | Overall width of the carrier tape |
| P1 | Pitch between successive cavity centers |

QUADRANT ASSIGNMENTS FOR PIN 1 ORIENTATION IN TAPE



*All dimensions are nominal

| | Device | Package Type | Package Drawing | | | Reel Diameter (mm) | Reel Width W1 (mm) | A0 (mm) | B0 (mm) | K0 (mm) | P1 (mm) | W (mm) | Pin1 Quadrant |
|---|------------------|-----------------|--------------------|----|------|--------------------------|--------------------------|---------|---------|---------|------------|-----------|------------------|
| ĺ | SN74LVT16543DGGR | TSSOP | DGG | 56 | 2000 | 330.0 | 24.4 | 8.6 | 15.6 | 1.8 | 12.0 | 24.0 | Q1 |
| | SN74LVT16543DLR | SSOP | DL | 56 | 1000 | 330.0 | 32.4 | 11.35 | 18.67 | 3.1 | 16.0 | 32.0 | Q1 |





*All dimensions are nominal

| Device | Package Type | Package Drawing | Pins | SPQ | Length (mm) | Width (mm) | Height (mm) |
|------------------|--------------|-----------------|------|------|-------------|------------|-------------|
| SN74LVT16543DGGR | TSSOP | DGG | 56 | 2000 | 346.0 | 346.0 | 41.0 |
| SN74LVT16543DLR | SSOP | DL | 56 | 1000 | 346.0 | 346.0 | 49.0 |

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